

General Description

It's mainly suitable for low voltage applications such as automotive, DC/DC converters and a load switch in battery powered applications

FEATURES

- $V_{DSS} = 60V$, $I_D = 60A$
- Drain-Source ON Resistance :
 $R_{DS(ON)} = 14m\Omega$ (Max.) @ $V_{GS} = 10V$

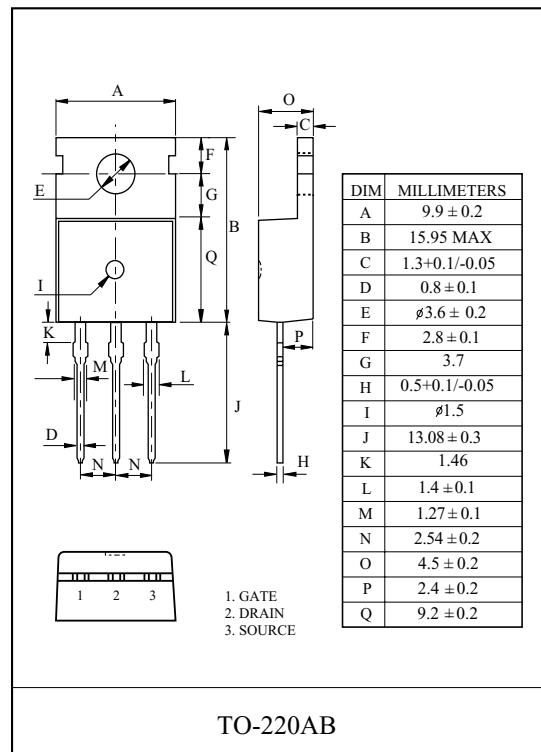
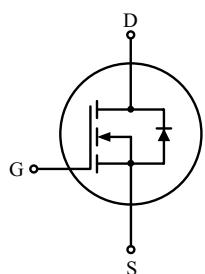
MOSFET MAXIMUM RATING (Ta=25 °C Unless otherwise noted)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	± 25	V
Drain Current	DC	I_D^*	60	A
	Pulsed (Note 1)	I_{DP}	240	A
Drain-Source Diode Forward Current		I_S	60	A
Drain Power Dissipation		P_D^* 25 °C	150	W
Maximum Junction Temperature		T_j	-55 ~ 175	°C
Storage Temperature Range		T_{stg}	-55 ~ 175	°C

Note1) Pulse Test : Pulse width $\leq 10\mu S$ Duty cycle $\leq 1\%$

Thermal Characteristics

CHARACTERISTIC	SYMBOL	RATING	UNIT
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	°C/W
Thermal Resistance, Junction-to-Case	R_{thJC}	1.0	°C/W

Equivalent Circuit

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MOSFET Electrical Characteristics (Ta=25 °C Unless otherwise noted)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250 μA, V _{GS} =0V	60	-	-	V
Drain Cut-off Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V,	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} =±15V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{th}	V _{DS} =V _{GS} , I _D =250 μA	2.0	-	4.0	V
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	11.5	14	mΩ
Forward Transconductance	g _{FS}	V _{DS} =15V, I _D =30A	-	20	-	S
Dynamic						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	2000	-	pF
Output Capacitance	C _{oss}		-	360	-	
Reverse Transfer Capacitance	C _{rss}		-	125	-	
Total Gate Charge	Q _g	V _{DS} =48V, V _{GS} =10V, I _D =30A	-	70	-	nC
Gate-Source Charge	Q _{gs}		-	15	-	
Gate-Drain Charge	Q _{gd}		-	20	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} =30V I _D =30A R _G =25 Ω	-	35	-	ns
Turn-On Rise Time	t _r		-	220	-	
Turn-Off Delay Time	t _{d(off)}		-	55	-	
Turn-Off Fall Time	t _r		-	30	-	

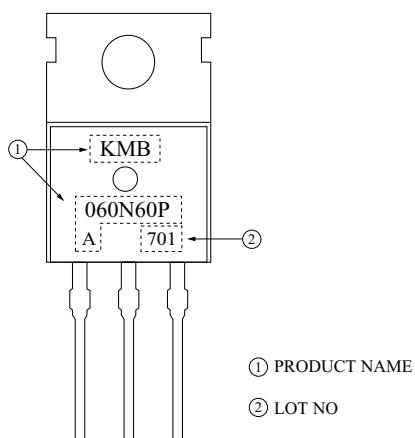
Note 1) Pulse Test : Pulse width ≤ 10μs, Duty Cycle ≤ 1%.

Note 2) Essentially Independent of Operating Temperature.

DIODE Electrical Characteristics (Ta=25 °C Unless otherwise noted)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Diode Forward Voltage	V _{SD}	I _{SD} =60A, V _{GS} =0V	-	-	1.5	V
Reverse Recovery Time	T _{rr}	V _{GS} =0V, I _S =60A, dI/dt=100A/μs	-	110	-	ns

Marking



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Fig 1. I_D - V_{DS}

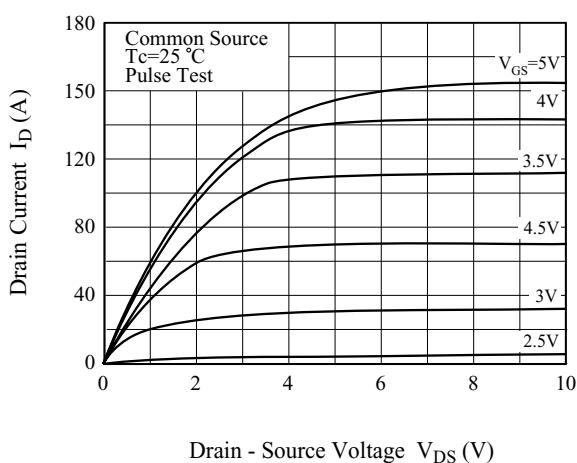


Fig 2. $R_{DS(ON)}$ - I_D

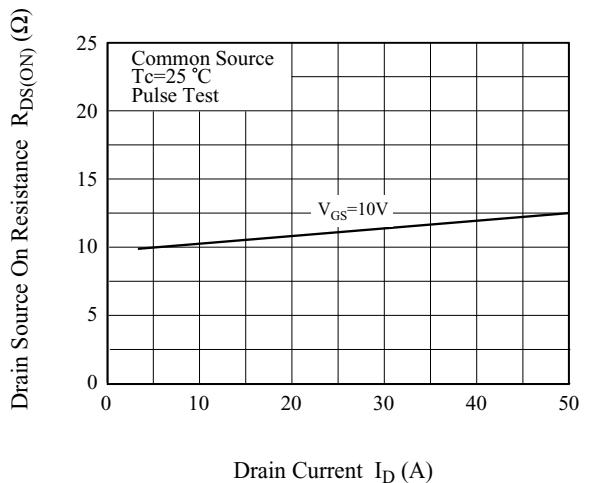


Fig 3. I_D - V_{GS}

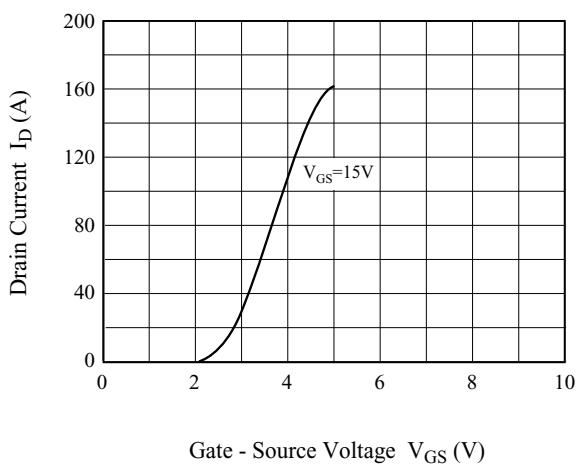


Fig 4. $R_{DS(ON)}$ - T_j

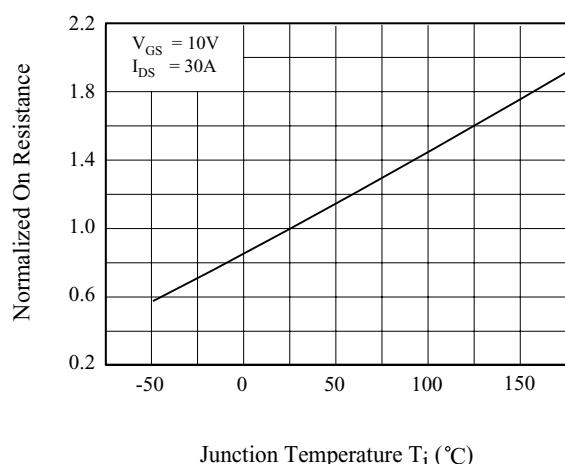


Fig 5. V_{th} - T_j

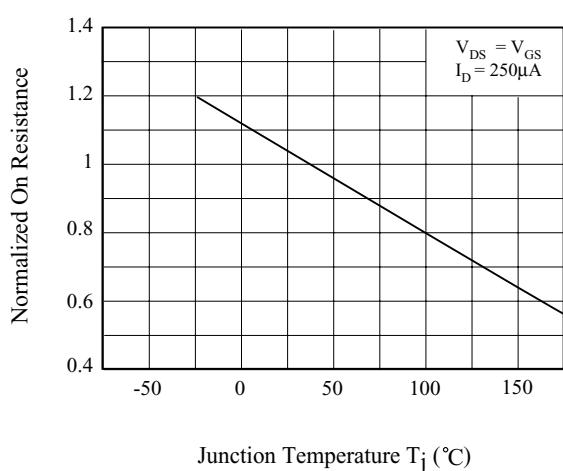
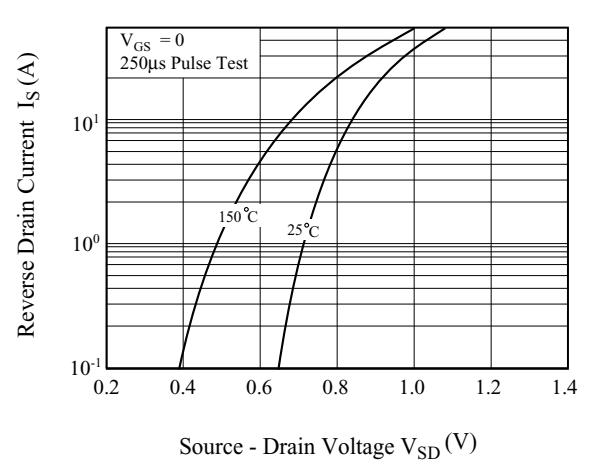


Fig 6. I_{DR} - V_{DSF}



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Fig 7. Q_g - V_{DS}

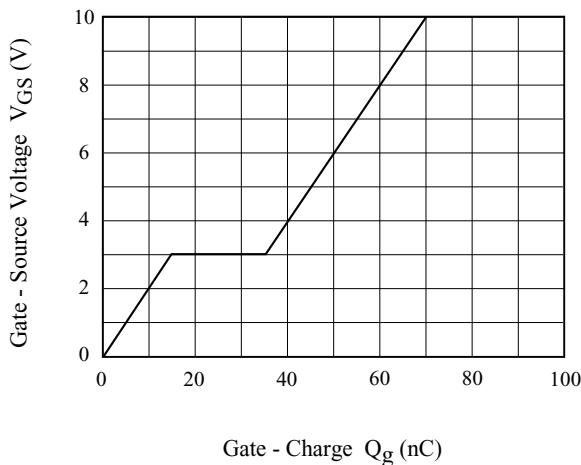


Fig 8. C - V_{DS}

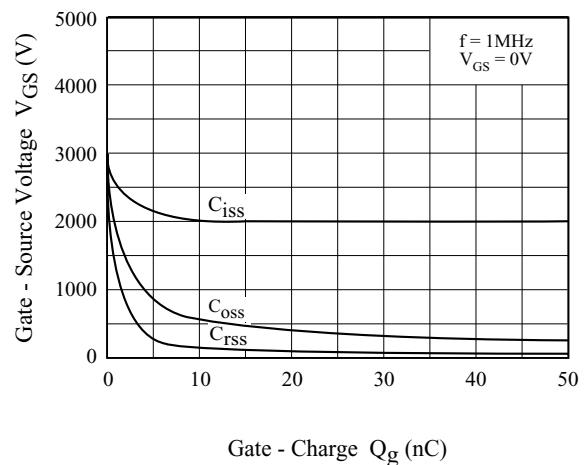


Fig 9. Safe Operation Area

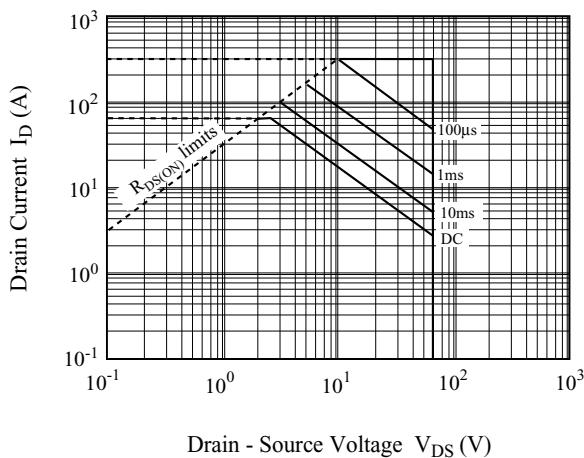


Fig 9. I_D - T_j

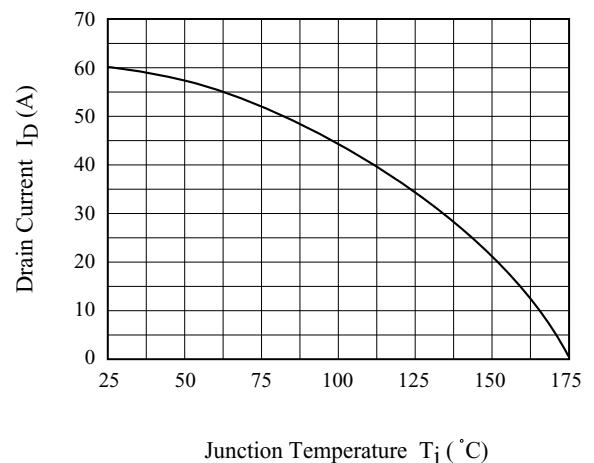
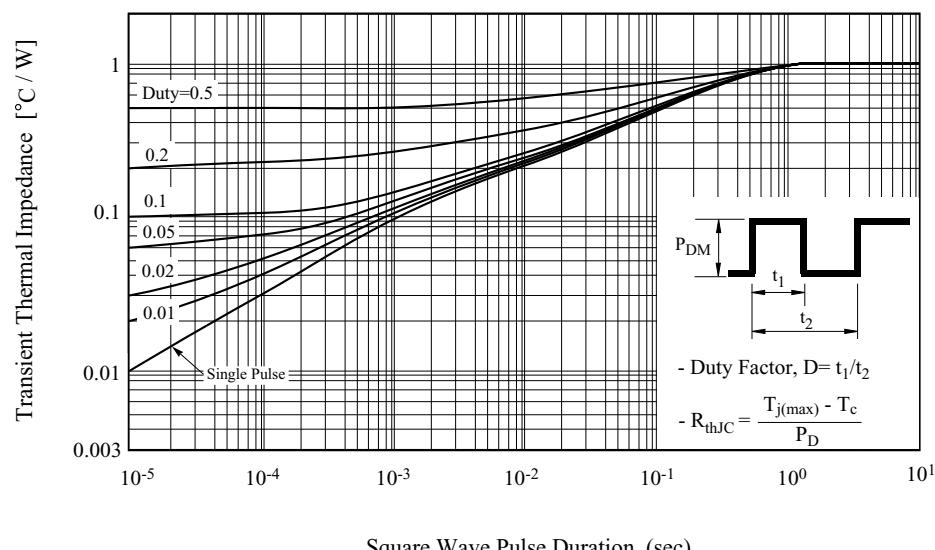
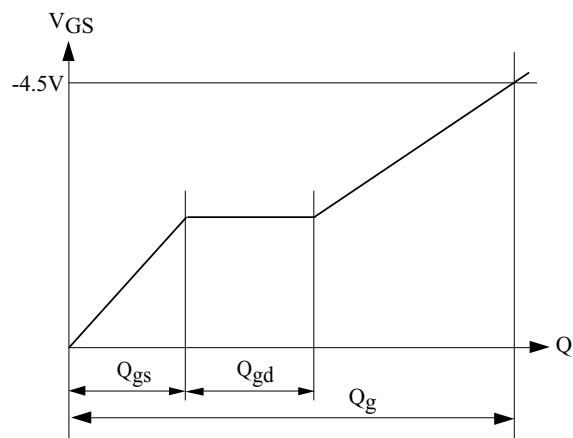
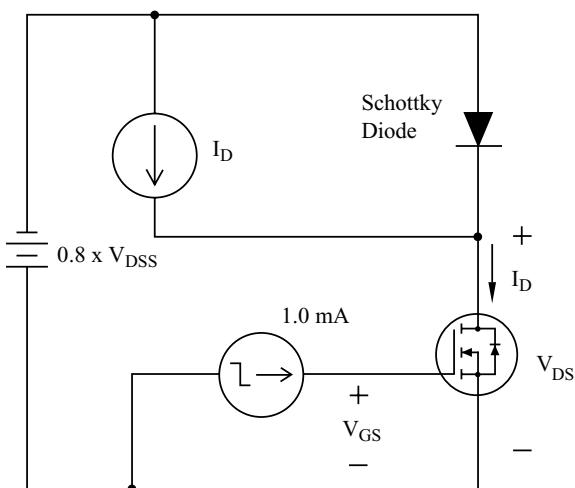


Fig 11. R_{th}

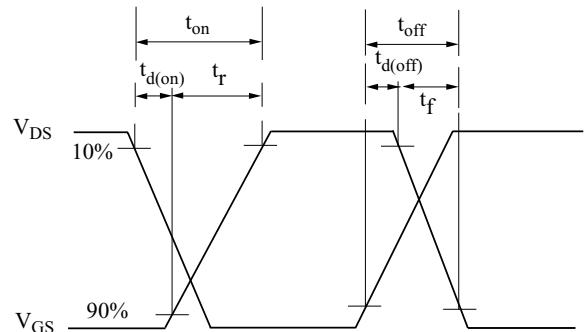
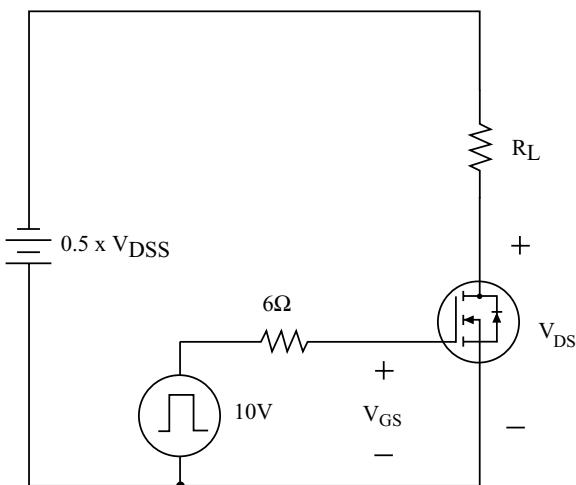


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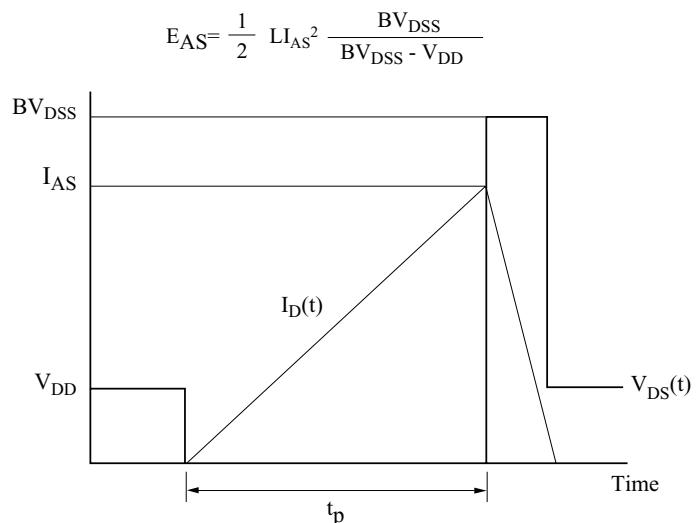
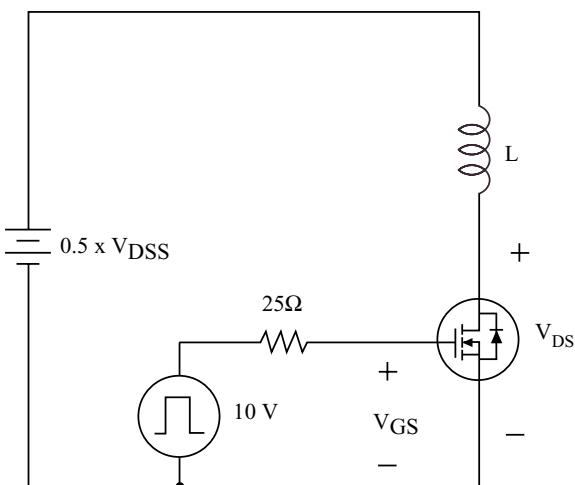
- Gate Charge



- Resistive Load Switching



- Single Pulsed Avalanche Energy



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- Source - Drain Diode Reverse Recovery and dv / dt

